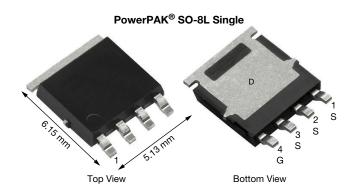


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Vishay Siliconix

Automotive N-Channel 80 V (D-S) 175 °C MOSFET



PRODUCT SUMMARY				
V _{DS} (V)	80			
$R_{DS(on)}$ (Ω) at $V_{GS} = 10 \text{ V}$	0.0190			
$R_{DS(on)}$ (Ω) at $V_{GS} = 4.5 \text{ V}$	0.0240			
I _D (A) per leg	30			
Configuration	Single			

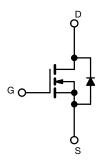
FEATURES

- TrenchFET® power MOSFET
- AEC-Q101 qualified
- 100 % R_q and UIS tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912





ROHS COMPLIANT HALOGEN FREE



N-Channel MOSFET

ORDERING INFORMATION	
Package	PowerPAK SO-8L
Lead (Pb)-free and halogen-free	SQJA86EP-T1 (for detailed order number please see www.vishay.com/doc?79771)

ABSOLUTE MAXIMUM RATIN	GS ($T_C = 25$ °C, unles	s otherwise noted	l)	
PARAMETER		SYMBOL	LIMIT	UNIT
Drain-source voltage		V _{DS}	80	V
Gate-source voltage		V _{GS}	± 20	V
Continuous drain current	T _C = 25 °C ^a	1	30	
	T _C = 125 °C	I _D	20	
Continuous source current (diode conduction) a		I _S	30	Α
Pulsed drain current ^b		I _{DM}	84	
Single pulse avalanche current L = 0.1 mH		I _{AS}	20	
Single pulse avalanche energy	L = 0.1 MH	E _{AS}	20	mJ
Maximum power dissipation ^b	T _C = 25 °C	D	48	W
	T _C = 125 °C	P_{D}	16	VV
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +175	°C
Soldering recommendations (peak temperature) d, e			260	C

THERMAL RESISTANCE RATINGS				
PARAMETER		SYMBOL	LIMIT	UNIT
Junction-to-ambient	PCB mount c	R_{thJA}	70	°C/W
Junction-to-case (drain)		R _{thJC}	3.1	C/VV

Notes

- a. Package limited
- b. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %
- c. When mounted on 1" square PCB (FR4 material)
- d. See solder profile (www.vishay.com/doc?73257). The PowerPAK SO-8L is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection
- e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components



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PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static							
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		80	-	-	V
Gate-source threshold voltage	V _{GS(th)}	V _{DS} =	· V _{GS} , I _D = 250 μA	1.5	2.0	2.5	v
Gate-source leakage	I _{GSS}	V _{DS} =	0 V, V _{GS} = ± 20 V	-	-	± 100	nA
		$V_{GS} = 0 V$	V _{DS} = 80 V	-	-	1	
Zero gate voltage drain current	I_{DSS}	$V_{GS} = 0 V$	V _{DS} = 80 V, T _J = 125 °C	-	-	50	μΑ
		V _{GS} = 0 V	V _{DS} = 80 V, T _J = 175 °C	-	-	150	
On-state drain current ^a	I _{D(on)}	V _{GS} = 10 V	$V_{DS} \ge 5 \text{ V}$	20	-	-	Α
	, ,	V _{GS} = 10 V	I _D = 8 A	-	0.0155	0.0190	
Durin and a state and a second	5	V _{GS} = 4.5 V	I _D = 5 A	-	0.0196	0.0240	
Drain-source on-state resistance ^a	$R_{DS(on)}$	V _{GS} = 10 V	I _D = 8 A, T _J = 125 °C	-	-	0.0317	Ω
		V _{GS} = 10 V	I _D = 8 A, T _J = 175 °C	-	-	0.0395	
Forward transconductance b	9fs	V _{DS}	= 15 V, I _D = 8 A	-	29	-	S
Dynamic ^b							
Input capacitance	C _{iss}			-	1015	1400	
Output capacitance	Coss	$V_{GS} = 0 V$	V _{DS} = 25 V, f = 1 MHz	-	445	600	рF
Reverse transfer capacitance	C _{rss}	1		-	25	35	
Total gate charge ^c	Qg			-	20	32	
Gate-source charge ^c	Q _{gs}	V _{GS} = 10 V	$V_{DS} = 40 \text{ V}, I_D = 1.5 \text{ A}$	-	3.6	-	nC
Gate-drain charge ^c	Q_{gd}	1		-	3.2	-	
Gate resistance	R_g		f = 1 MHz	0.23	0.49	0.8	Ω
Turn-on delay time ^c	t _{d(on)}			-	10	20	
Rise time ^c	t _r	$V_{DD} =$	40 V, $R_L = 26.7 \Omega$	-	3	10	1
Turn-off delay time °	t _{d(off)}	I _D ≅ 1.5 A,	V_{GEN} = 10 V, R_g = 1 Ω	-	23	40	ns
Fall time ^c	t _f	1		-	24	40	
Source-Drain Diode Ratings and Charac	teristics ^b			l		l	l
Pulsed current ^a	I _{SM}			-	-	84	Α
Forward voltage	V _{SD}	l _F =	= 8 A, V _{GS} = 0 V	-	0.84	1.2	V
Body diode reverse recovery time	t _{rr}			-	38	80	ns
Body diode reverse recovery charge	Q _{rr}	1	A 31/31 400 A/ -	-	43	100	nC
Reverse recovery fall time	ta	$I_F = 5$	A, di/dt = 100 A/μs	-	23	-	
Reverse recovery rise time	t _b	1		-	19	-	ns
Body diode peak reverse recovery current	I _{RM(REC)}			-	-2.1	-5	Α

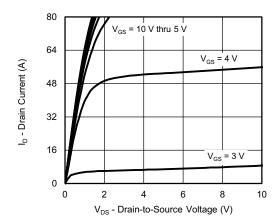
Notes

- a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

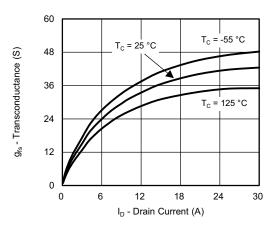
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



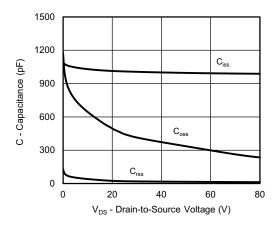
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



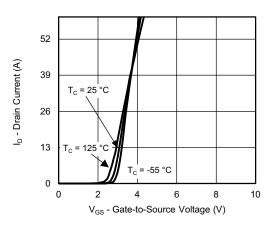
Output Characteristics



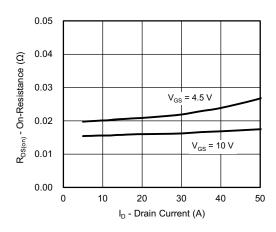
Transconductance



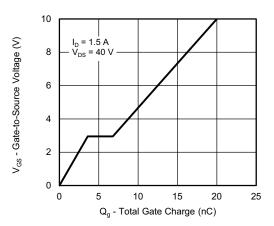
Capacitance



Transfer Characteristics



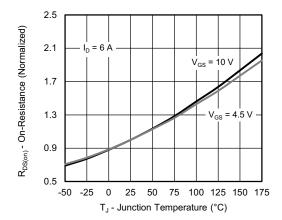
On-Resistance vs. Drain Current



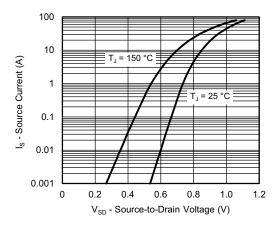
Gate Charge



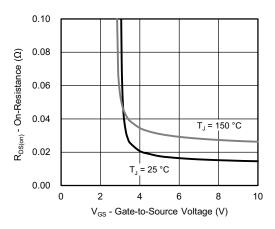
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



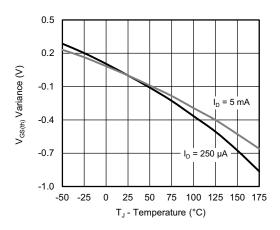
On-Resistance vs. Junction Temperature



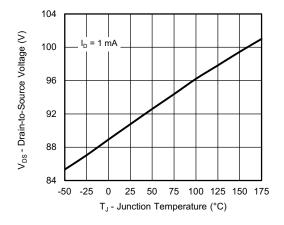
Source Drain Diode Forward Voltage



On-Resistance vs. Gate-to-Source Voltage



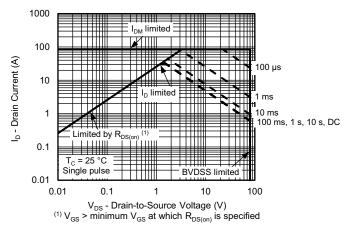
Threshold Voltage



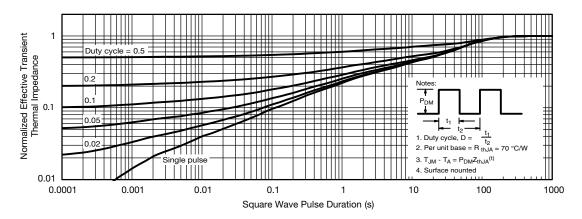
Drain Source Breakdown vs. Junction Temperature



THERMAL RATINGS ($T_A = 25$ °C, unless otherwise noted)



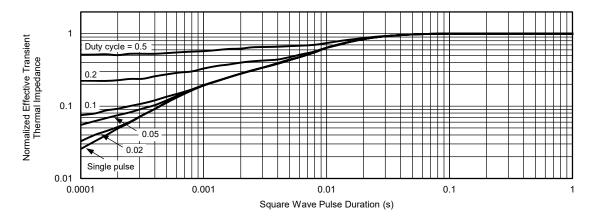
Safe Operating Area



Normalized Thermal Transient Impedance, Junction-to-Ambient



THERMAL RATINGS (T_A = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Case

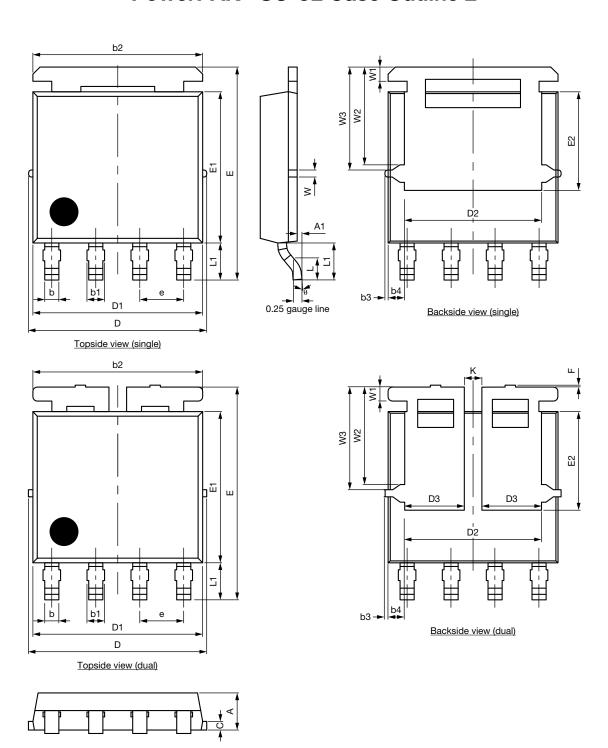
Note

- The characteristics shown in the two graphs
 - Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)
 - Normalized Transient Thermal Impedance Junction-to-Case (25 °C) are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?75246.



PowerPAK® SO-8L Case Outline 2





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DIM	MILLIMETERS			INCHES		
DIM.	MIN.	NOM.	MAX.	MIN.	MIN. NOM.	
А	1.00	1.07	1.14	0.039	0.042	0.045
A1	0.00	-	0.127	0.00	-	0.005
b	0.33	0.41	0.48	0.013	0.016	0.019
b1	0.44	0.51	0.58	0.017	0.020	0.023
b2	4.80	4.90	5.00	0.189	0.193	0.197
b3		0.094			0.004	
b4		0.47			0.019	
С	0.20	0.25	0.30	0.008	0.010	0.012
D	5.00	5.13	5.25	0.197	0.202	0.207
D1	4.80	4.90	5.00	0.189	0.193	0.197
D2	3.86	3.96	4.06	0.152	0.156	0.160
D3	1.63	1.73	1.83	0.064	0.068	0.072
е		1.27 BSC		0.050 BSC		
E	6.05	6.15	6.25	0.238	0.242	0.246
E1	4.27	4.37	4.47	0.168	0.172	0.176
E2	2.75	2.85	2.95	0.108	0.112	0.116
F	-	-	0.15	-	-	0.006
L	0.62	0.72	0.82	0.024	0.028	0.032
L1	0.92	1.07	1.22	0.036	0.042	0.048
K		0.51	•		0.020	
W	0.23			0.009		
W1	0.41			0.016		
W2	2.82		0.111			
W3	2.96 0.117					
θ	0°	-	10°	0°	-	10°

ECN: C21-1498-Rev. C, 01-Nov-2021

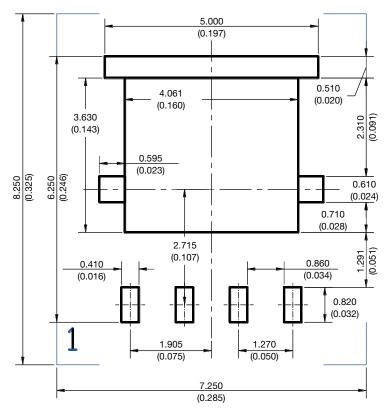
DWG: 6044

Note

• Millimeters will govern



RECOMMENDED MINIMUM PAD FOR PowerPAK® SO-8L SINGLE



Recommended Minimum Pads Dimensions in mm (inches)

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